

Micro-Thermal analysis of liquid phenol-formaldehyde resin on wood surface

by

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Introduction

- The durability and strength of wood based composites depend on the cured state of the binder.
- Wood can affect curing of the PF resin.
- Conventionally DSC has been used to trace the curing reaction with time. (Bulk reaction \neq local interactions)
- It is essential to employ a technique which can identify wood species that enhances or retards curing reaction.

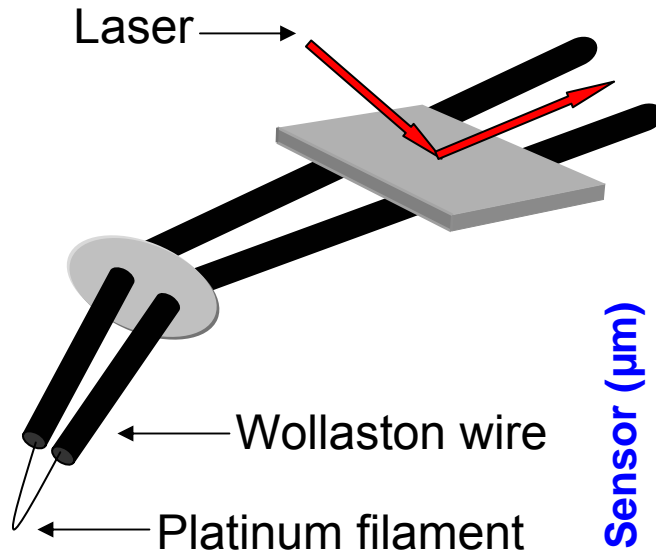
μ -TA an Introduction

- μ -TA is a hybrid which combines the principles of atomic force microscopy (AFM) with thermal analysis.
- Resistive thermal probe is used instead of AFM tip.
- The thermal probe is composed of Wollaston wire which acts as a heater and sensor measuring tip movement and heat absorption on the sample surface.

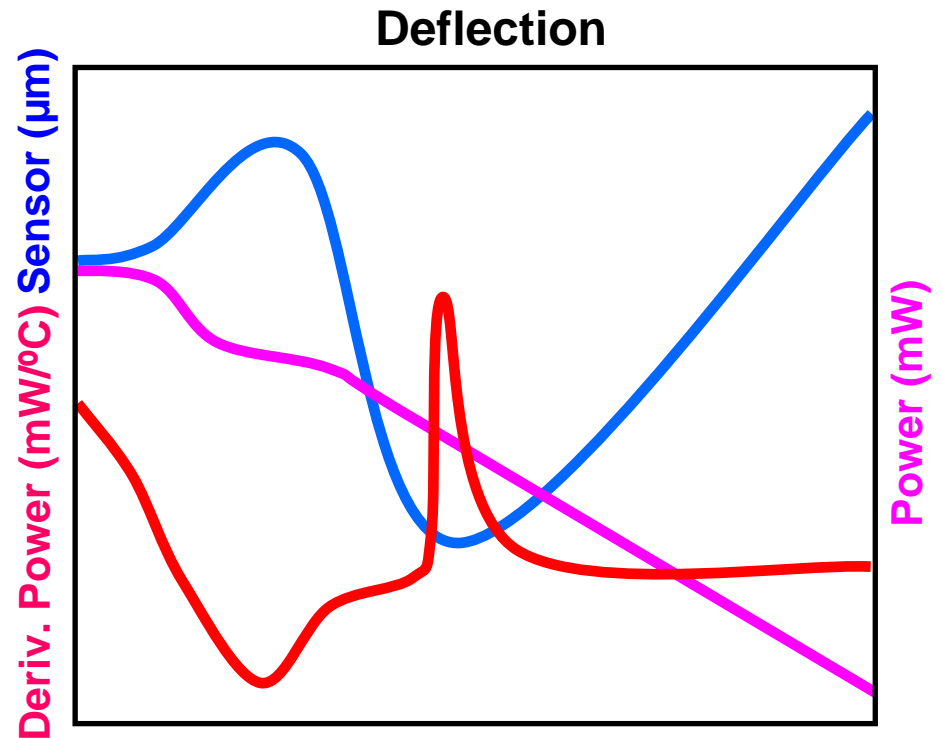
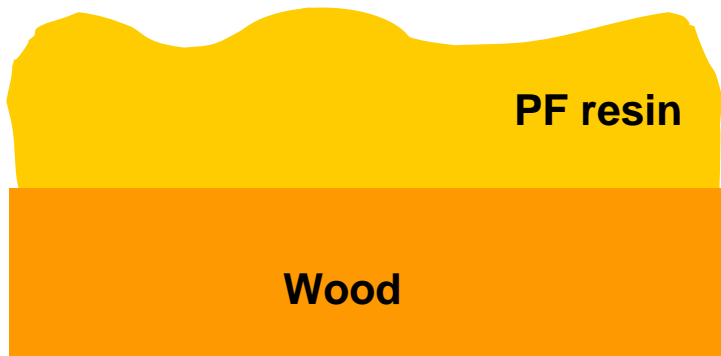
Local Thermal Analysis (LTA)

- With the application of high voltage it is possible to apply high temperature to specific regions of the sample.
- Thermal tip is placed on a particular location on the sample surface and heating is ramped at a predetermined rate.
- The probe tip sinks into the sample surface.
- The response of the tip to increasing voltage is continuously monitored in terms of the sensor response (tip vertical displacement) and power (heat absorption).

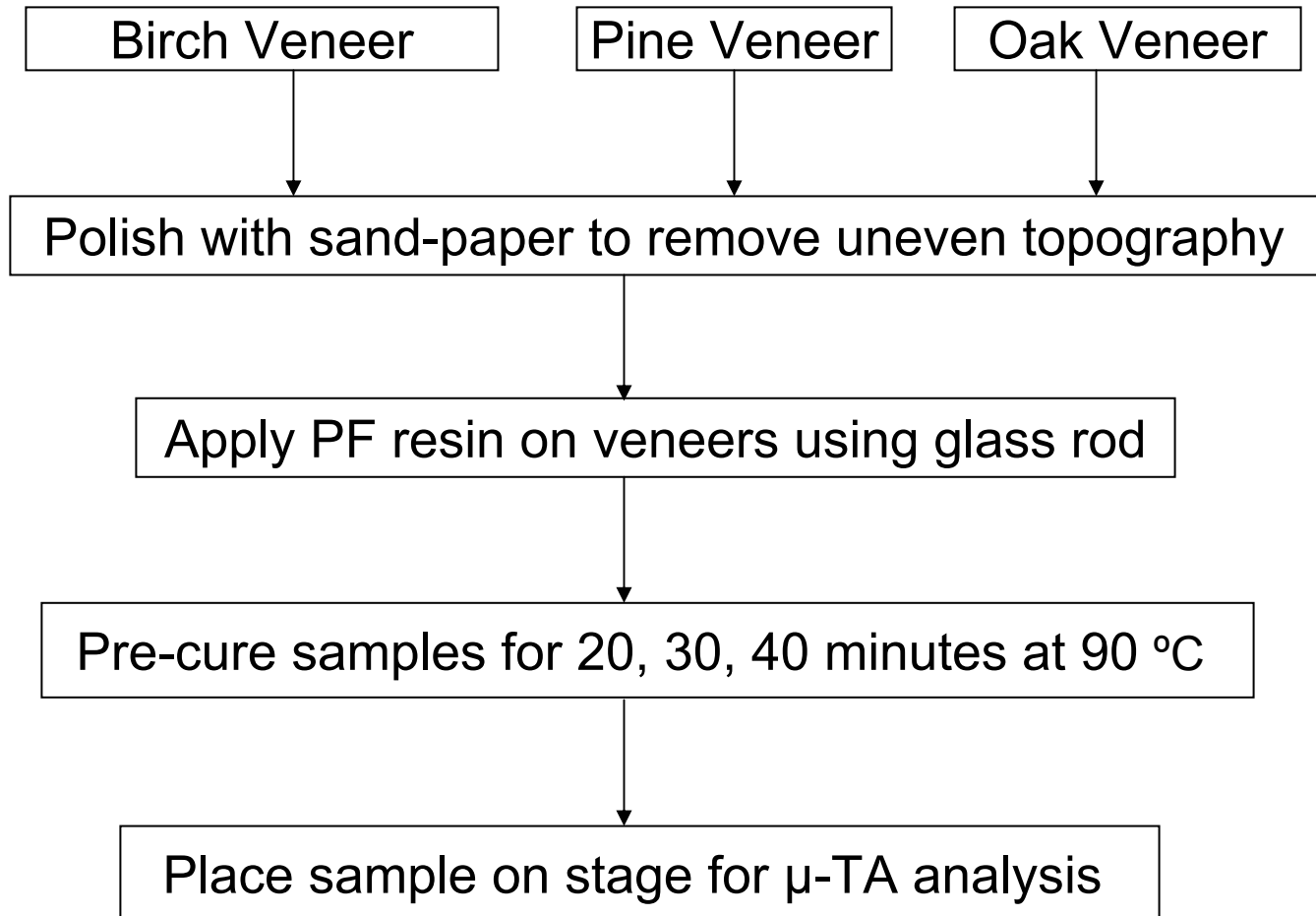
Local Thermal Analysis (LTA) Methodology



Heating rate = 25 °C/Second

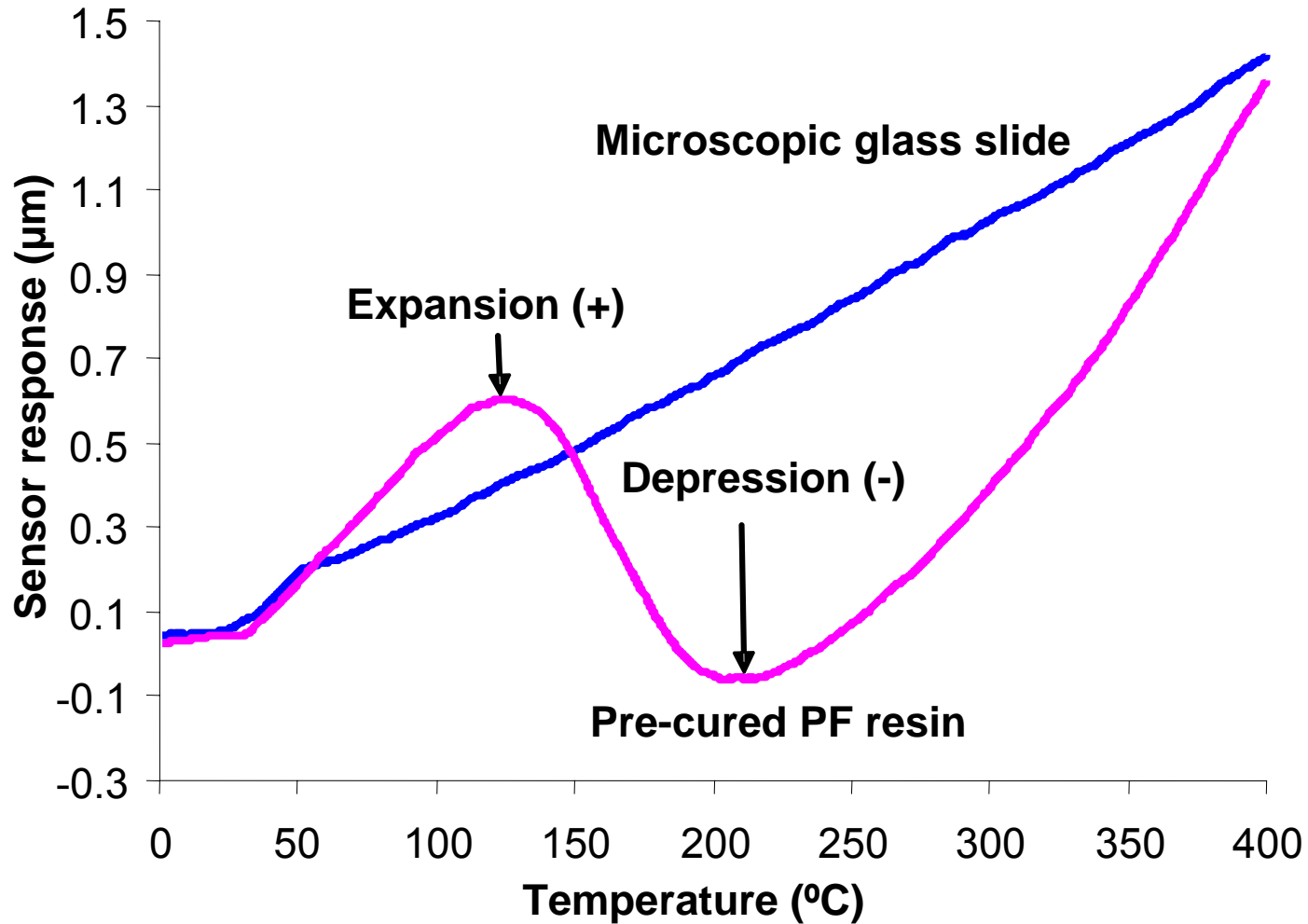


Experimental Procedure



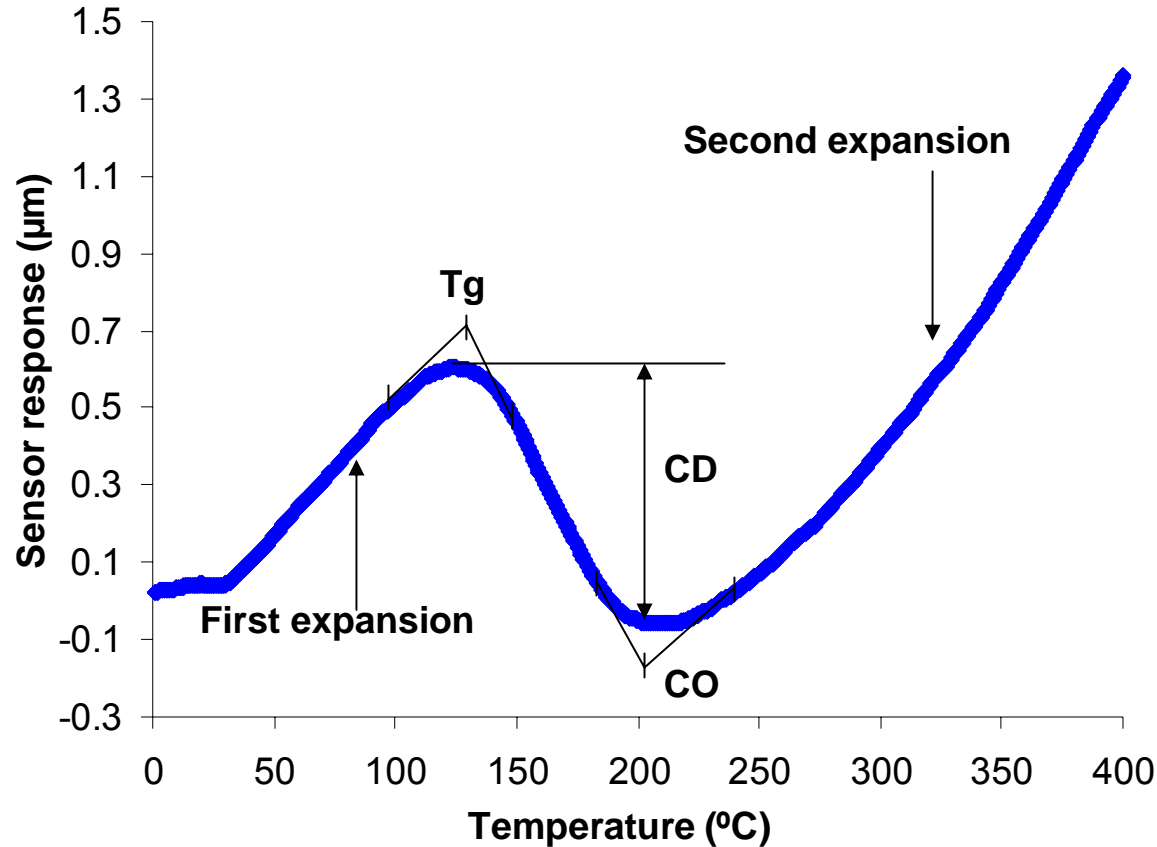
Cure temperature was set to 90 °C to obtain optimum cure state to prevent sticking of resin onto the probe.

Comparison of LTA results on glass plate and Pre-cured PF resin at 90 °C for 30 minutes



Glass – Linear expansion, PF resin – Sinusoidal behavior

Analysis of Sensor Response

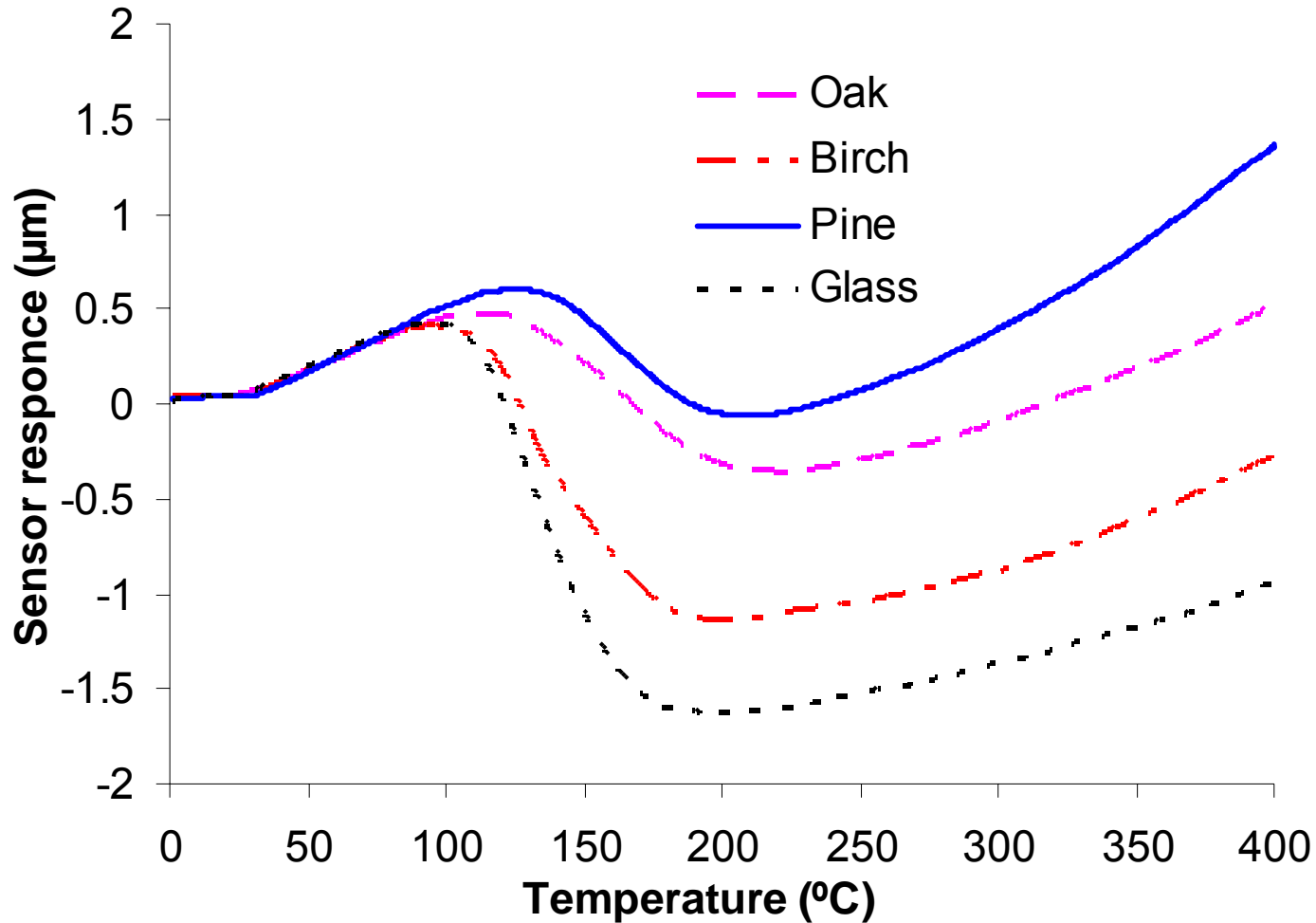


Tg – Glass transition temperature

CD – Cantilever Deflection

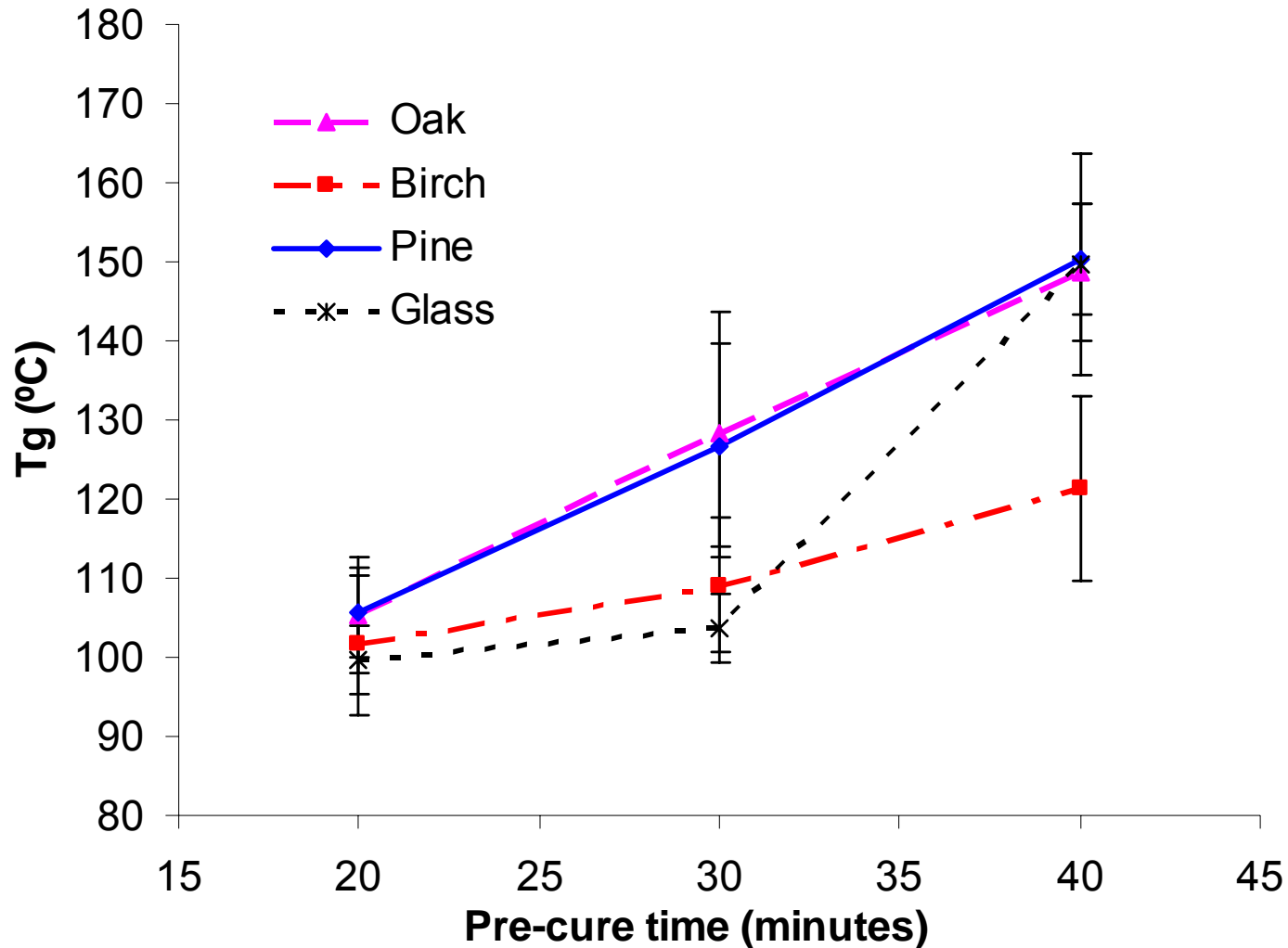
CO – Cure onset

LTA analysis of PF resin on different substrates pre-cured at 90 °C for 30 minutes



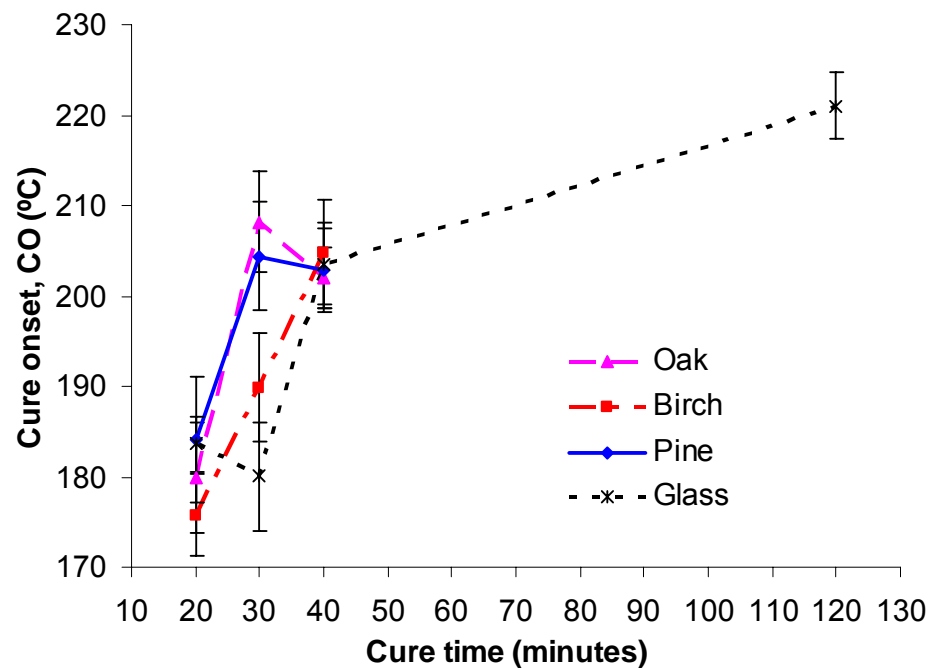
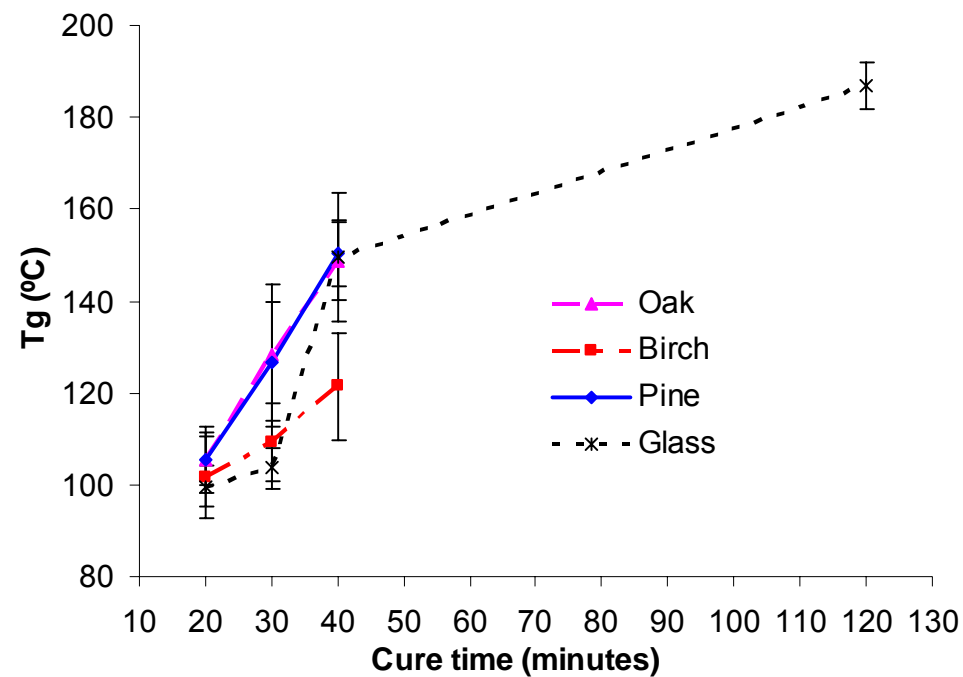
Difference in sensor response attributes to different cure behavior.

T_g of PF on different substrates pre-cured at 90°C

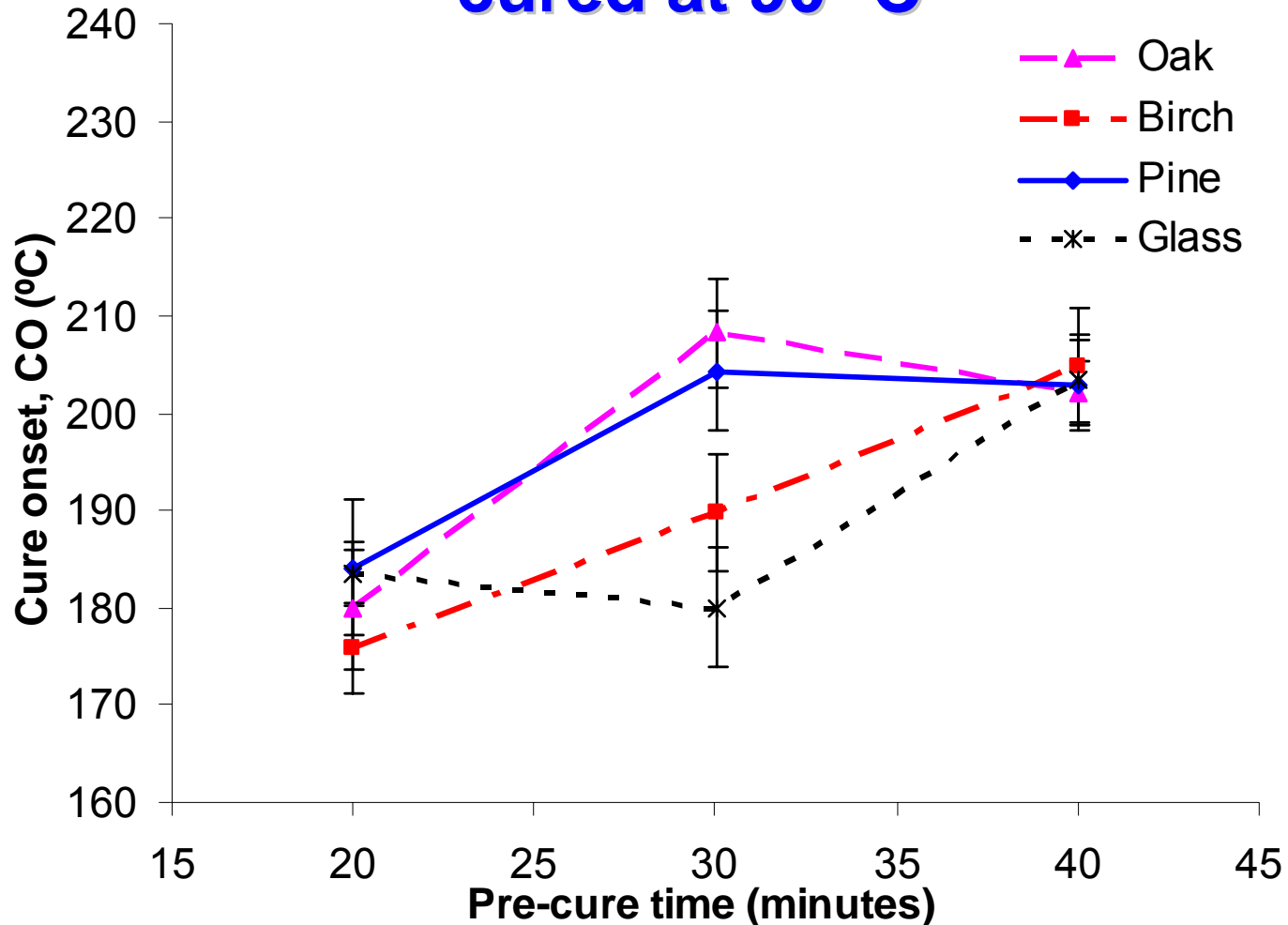


T_g values are higher after 30 minutes of pre-cure for pine and oak which signifies faster polymerisation reaction compared to birch and glass.

Tg & Cure-onset of PF on glass substrate pre-cured at 90 °C for 120 minutes

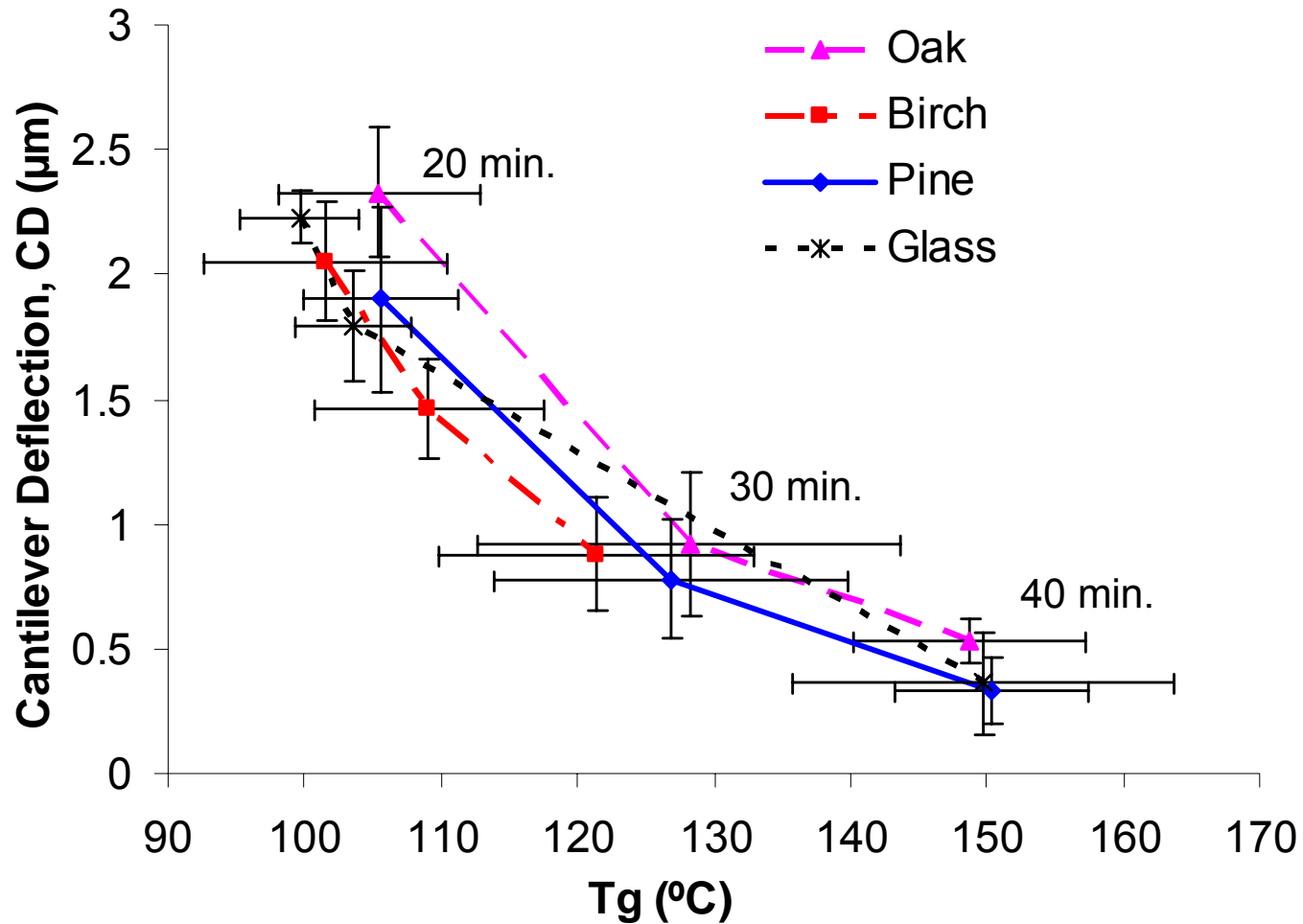


Cure-onset of PF on different substrates pre-cured at 90 °C



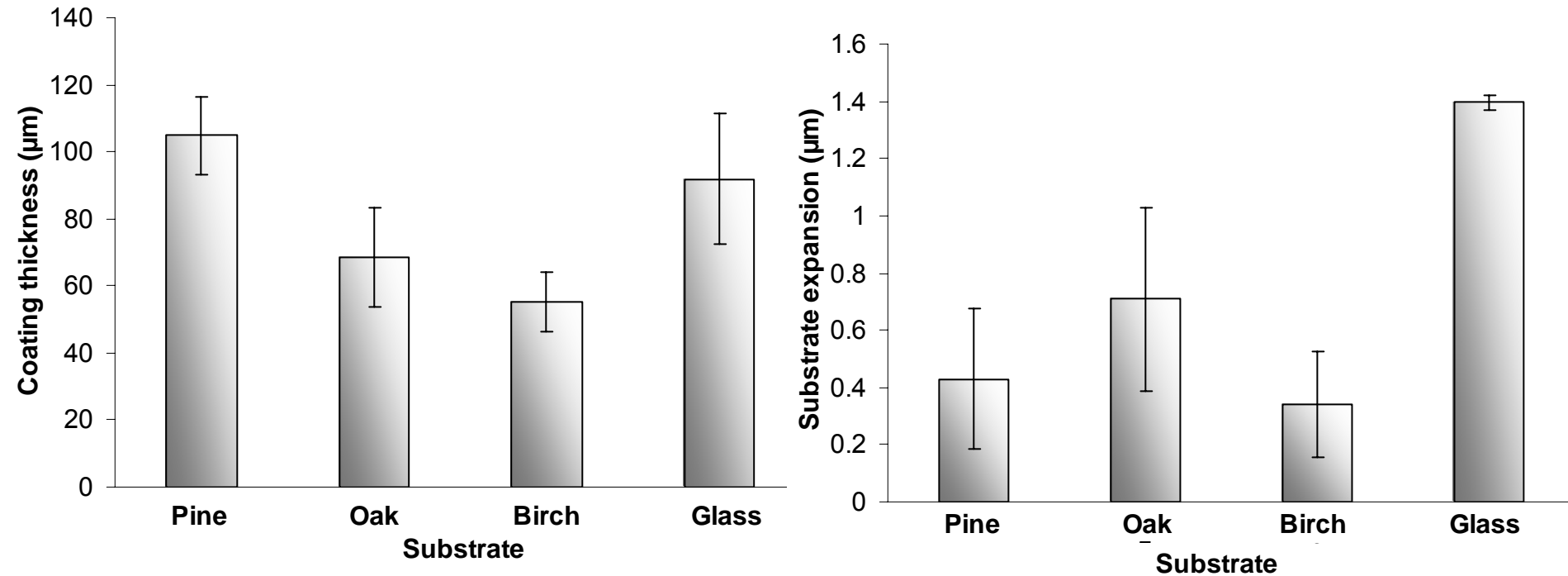
Cure onset decreases with the increase in cure time for oak and pine while it increases for birch and glass.

Cantilever deflection measured for PF on different substrates pre-cured at 90 °C



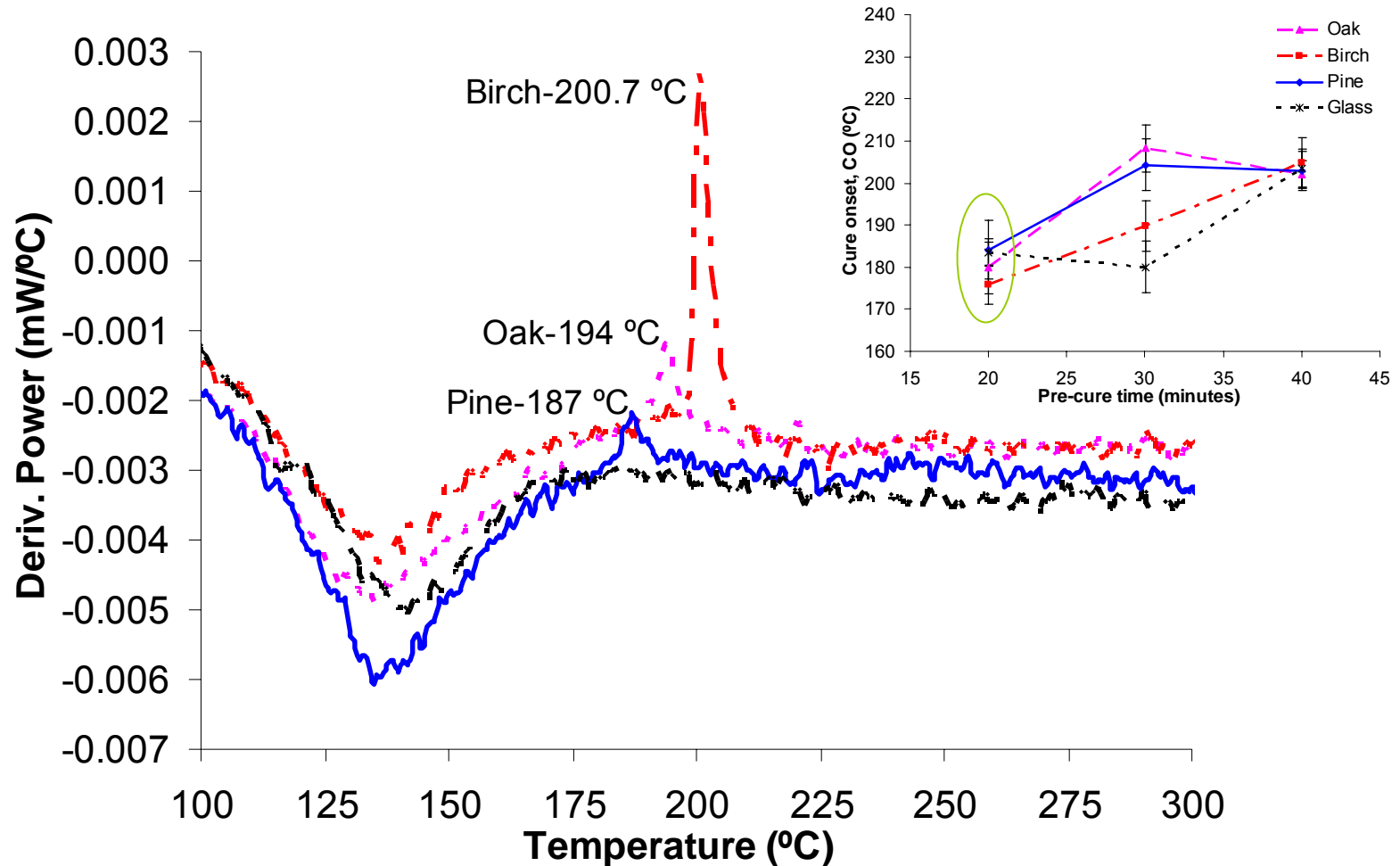
Cantilever Deflection decreases with increase in glass transition temperature (Tg).

Comparison of coating thickness and substrate expansion



- Coating thickness is well above substrate expansion.
- This avoids probe contacting with the veneer.

Cure exotherm detected for PF on different substrates pre-cured at 90 °C for 20 minutes



Cure exotherm temperature decreases with increase in the degree of cure.

Conclusions

- μ -TA was successfully used to identify the differences in curing behavior of PF resin caused by different substrates.
- Important thermal parameters such as glass transition temperature and cure onset were measured for partially cured PF resin.
- Pine and oak veneers were found to accelerate the curing process while birch veneer retarded the cure process.
- Cure exotherms associated with resin cure were detected for all wood substrates. However, for glass substrate no significant exotherms were detected suggesting catalytic activity of wood substrates.

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Comparison of μ -TA results with DSC results

